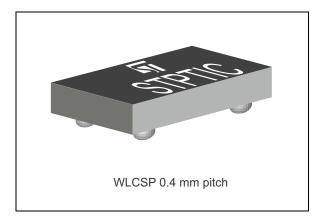


# STPTIC-39G2

### Parascan<sup>™</sup> tunable integrated capacitor

Datasheet - production data



### Features

- High power capability
- 5:1 tuning range
- High linearity
- High quality factor (Q)
- Low leakage current
- Compatible with high voltage control IC (STHVDAC series)
- Available in wafer level chip scale package:
   WLCSP package 0.61 x 0.66 x 0.3 mm
- ECOPACK<sup>®</sup>2 compliant component

#### Benefit

 RF tunable passive implementation in mobile phones to optimize antenna radiated performance

### Applications

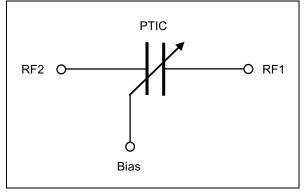
- Cellular antenna open loop tunable matching network in multi-band GSM/WCDMA/LTE mobile phone
- Open loop tunable RF filters

### Description

The ST integrated tunable capacitor offers excellent RF performance, low power consumption and high linearity required in adaptive RF tuning applications. The fundamental building block of PTIC is a tunable material called Parascan™, which is a version of barium strontium titanate (BST) developed by Paratek microwave.

BST capacitors are tunable capacitors intended for use in mobile phone application and dedicated to RF tunable applications. These tunable capacitors are controlled through an extended bias voltage ranging from 1 to 24 V. The implementation of BST tunable capacitor in mobile phones enables significant improvement in terms of radiated performance making the performance almost insensitive to the external environment.

#### Figure 1. PTIC functional block diagram



TM: Parascan is a trademark of Paratek Microwave Inc.

DocID028099 Rev 1

# 1 Electrical characteristics

Symbol	Parameter	Rating	Unit	
P <sub>IN</sub>	Input peak power RF <sub>IN</sub> (CW mode)/all RF ports	+40	dBm	
V <sub>ESD(HBM)</sub>	Human body model, JESD22-A114-B, all I/O	Class 1B <sup>(1)</sup>	V	
V <sub>ESD(MM)</sub>	Machine model, JESD22-A115-A, all I/O	100	V	
T <sub>device</sub>	Device temperature	+125	°C	
T <sub>stg</sub>	stg Storage temperature -55 to +150			
V <sub>x</sub>	Bias voltage	25	V	

#### Table 1. Absolute maximum ratings (limiting values)

1. Class 1B defined as passing 500 V, but fails after exposure to 1000V ESD pulse.

#### Table 2. Recommended operating conditions

Symbol	Parameter		Rating				
Symbol	Falanielei	Min.	Тур.	Max.	Unit		
P <sub>IN</sub>	RF input power		+33		dBm		
F <sub>OP</sub>	Operating frequency	700		2700	MHz		
T <sub>device</sub>	Device temperature			+100	°C		
T <sub>OP</sub>	Operating temperature	-30		+85	C		
V <sub>BIAS</sub>	Bias voltage	1		24	V		



Symbol	Deremeter	Conditions		Value			
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit	
C <sub>1V</sub>	capacitor at 1 V bias	STPTIC-39G2	3.96	4.5	5.04	pF	
C <sub>2V</sub>	capacitor at 2 V bias	STPTIC-39G2		3.9		pF	
C <sub>24V</sub>	capacitor at 24 V bias	STPTIC-39G2	0.72	0.78	0.84	pF	
ΔC	Tuning range	Ratio between $C_{1V}/C_{24V}^{(1)}$	5/1				
١ <sub>L</sub>	Leakage current	Measured with V <sub>bias</sub> = 24 V			100	nA	
Q <sub>LB</sub>	Quality factor	Measured at 700 MHz at 2 V	55	65			
Q <sub>HB</sub>	Quality factor	Measured at 2700 MHz at 2 V	35	50			
IP3	Third order intercept point	$V_{bias} = 1 V^{(2)(4)}$	52	60		dBm	
15		$V_{\text{bias}} = 24 V^{(2)(4)}$		75		UDIII	
H2	Second harmonic	$V_{bias} = 1 V^{(3)(4)}$		-65	-45	dBm	
пг		$V_{bias} = 24 V^{(3)(4)}$		-75		UDIII	
H3	Third harmonic	$V_{bias} = 1 V^{(3)(4)}$		-35	-30	dBm	
ПЭ		$V_{\text{bias}} = 24 V^{(3)(4)}$		-65		ubm	
+	Transition time	Average for any transition between $C_{min}$ to $C_{max}^{(5)}$		40			
t <sub>T</sub>		Average transition between $C_{max}$ to $C_{min}^{(5)}$		20		μs	

Table 3. Representative performance (T<sub>amb</sub> = 25 °C otherwise specified)

1. Measured at low frequency

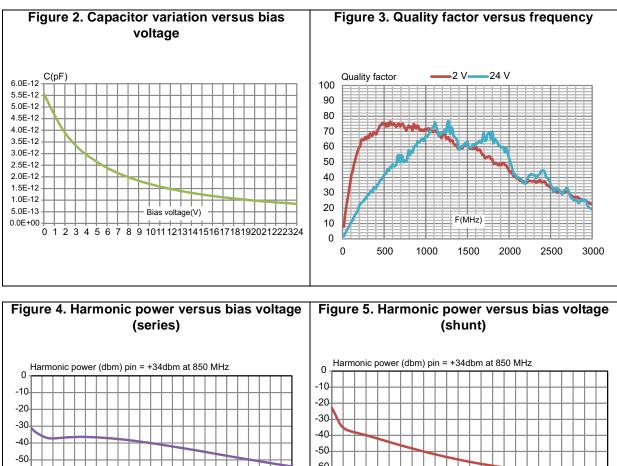
2.  $F_1$  = 894 MHz,  $F_2$  = 849 MHz,  $P_1$  = +25 dBm,  $P_2$  = +25 dBm,  $2f_1$  -  $f_2$  = 939 MHz

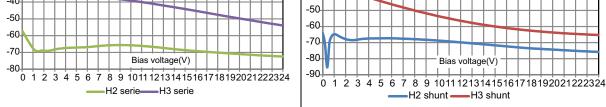
3. 850 MHz, P<sub>in</sub> = +34 dBm

4. IP3 and harmonics are measured in the shunt configuration in a 50  $\Omega$  environment

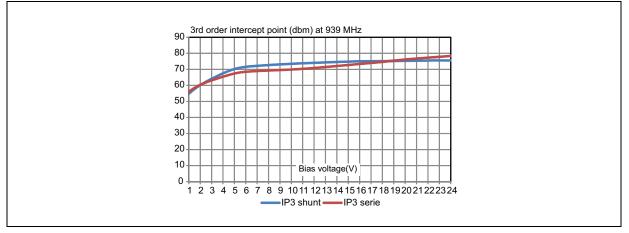
5. One or both of  ${\rm RF}_{\rm in}$  and  ${\rm RF}_{\rm out}$  must be connected to DC ground, using the HVDAC turbo mode







#### Figure 6. Third order intercept point (IP3)



DocID028099 Rev 1



### 2 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com.* ECOPACK<sup>®</sup> is an ST trademark.

### 2.1 Flip-Chip package information

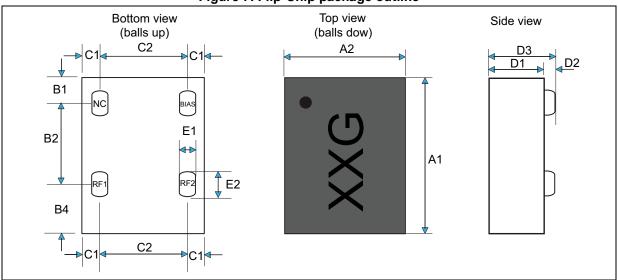


Figure 7. Flip-Chip package outline

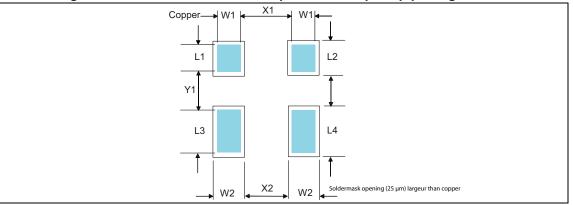
The land pattern below is recommended for soldering the STPTIC-G2 on PCB.

NC stands for No Connect, this pad must not be connected on application board. Please leave this pad floating.

Dimensions (micron)	A1	A2	B1	B2	B4	C1	C2	D1	D2	D3	E1	E2
STPTIC-15/27/33/39/47G2	640				120							
STPTIC-56G2	710	590	120	400	190	85	420	200	90	290	125	165
STPTIC-68G2	780			400	260	00 420	420	200	30	230	125	105
STPTIC-82G2	880				360							
Tolerance	±30	±30	±15	±10	±15	±15	±10	±20	±20	±40	±20	±20

Table 4. Flip-Chip package dimensions



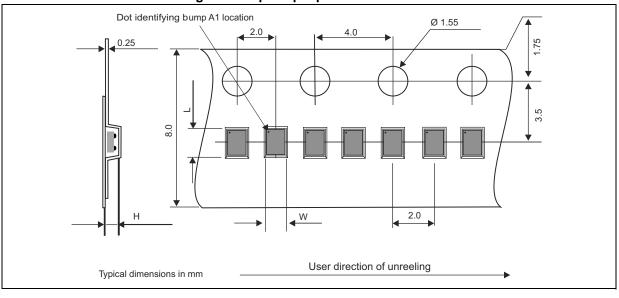




#### Table 5. Dimensions

Dimensions	L1	W1	L3	L2	W2	L4	X1	X2	Y1	Y2
Typical values (micron)	160	160	260	210	210	310	320	270	240	190

### 2.2 Packing information

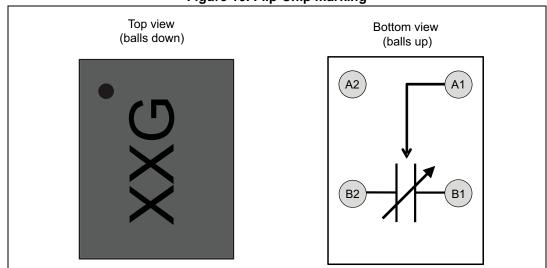


#### Figure 9. Flip-Chip tape and reel outline

**Table 6. Dimensions** 

Pocket dimensions	L	W	н
STPTIC-15/27/33/39/47G2	730	680	380
STPTIC-56G2	800	680	380
STPTIC-68G2	870	680	380
STPTIC-82G2	970	680	380





#### Figure 10. Flip-Chip marking

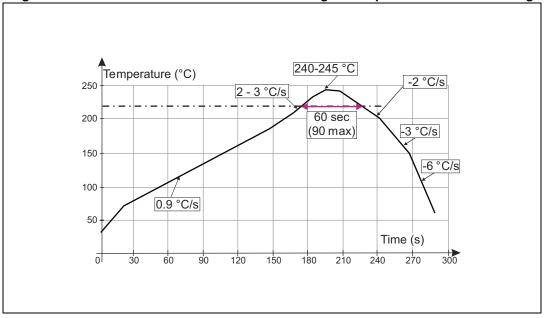
#### Table 7. Pinout description

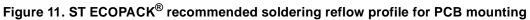
Pad / ball number	Pin name	Description
A1	DC bias	DC bias voltage
B1	RF2	RF input / output <sup>(1)</sup>
A2	NC	Not connected
B2	RF1	RF input / output

1. When connected in shunt, please connect RF2 (B1 ball) to GND



## 3 Reflow profile







Minimize air convection currents in the reflow oven to avoid component movement.

Profile	Value				
Prome	Typical	Max.			
Temperature gradient in preheat (T = 70-180 °C)	0.9 °C/s	3 °C/s			
Temperature gradient (T = 200-225 °C)	2 °C/s	3 °C/s			
Peak temperature in reflow	240-245 °C	260 °C			
Time above 220 °C	60 s	90 s			
Temperature gradient in cooling	-2 to -3 °C/s	-6 °C/s			
Time from 50 to 220 °C	160 to 220 s				

#### Table 8. Recommended values for soldering reflow



# 4 Evaluation board

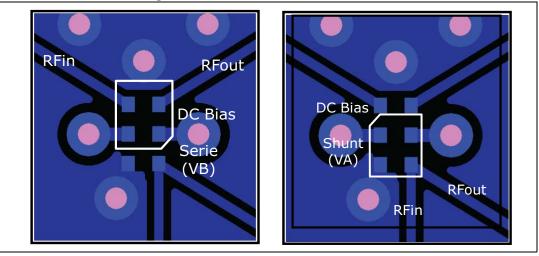


Figure 12. Series and shunt connection

Figure 13. Layer 1 and layer 4

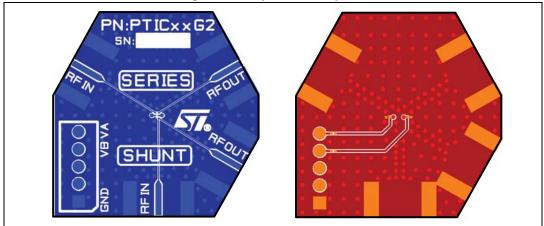
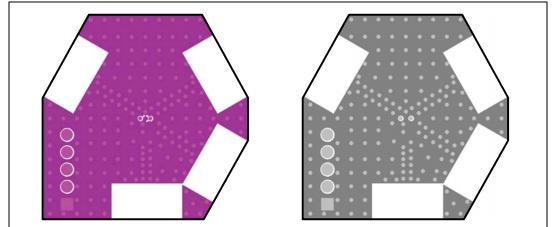


Figure 14. Layer 2 and layer 3





# 5 Ordering information

	l igure i	J. U		ormation schem		
ST	PTIC		15	G	2	C5
51	FIIC	-	15	9	2	03
<u>Manufacturer</u>	Product family	-	<u>Capacitor</u> <u>value</u>	Linearity	Tuning	<u>Package</u>
ST Microelectronics	PTIC Parascan™ tunable Integrated capacitor		12 = 1.2 pF 27 = 2.7 pF 33 = 3.3 pF 39 = 3.9 pF 47 = 4.7 pF 56 = 5.6 pF 68 = 6.8 pF 82 = 8.2 pF	F: Standard (x24) G: Standard (x24) L: High (x48)	1 = 4/1 tuning 2 = 5/1 tuning	M6 : QFN C5 : WLCSP

Figure 15. Ordering information scheme

 Table 9. Ordering information

Part number	Marking	Base qty	Package	Delivery mode
STPTIC-39G2C5	39G	15 000	Flip-Chip	Tape and reel

# 6 Revision history

Table 10	Document	revision	history
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Date	Revision	Changes
09-Jul-2015	1	Initial release.



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 GNR4R550
 GNR8R050
 GXL15000
 538-011 D 9-35LF
 PC39G520
 STPTIC-56G2C5
 27271LSL
 27281SL

 STPTIC-82G2C5
 27283-3R10
 GNL8R050
 GYB5R000
 0538-006-F-15.0-60LF
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 KJ8
 KT8
 KG10
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 KM10
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 KM4SD
 KT4SD
 KP4SD